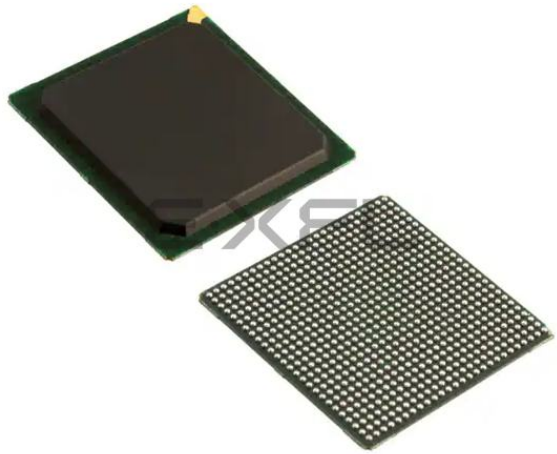

Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	3424
Number of Logic Elements/Cells	30816
Total RAM Bits	2506752
Number of I/O	416
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp30-5fgg676i

Figure 36, Figure 37, and Figure 38 illustrate various example configurations.

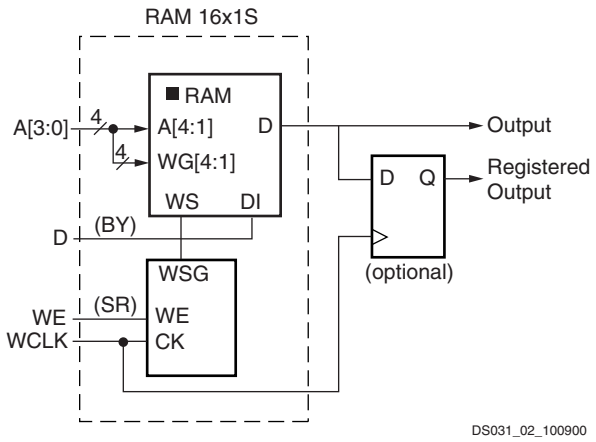

Figure 36: **Distributed SelectRAM+ (RAM16x1S)**

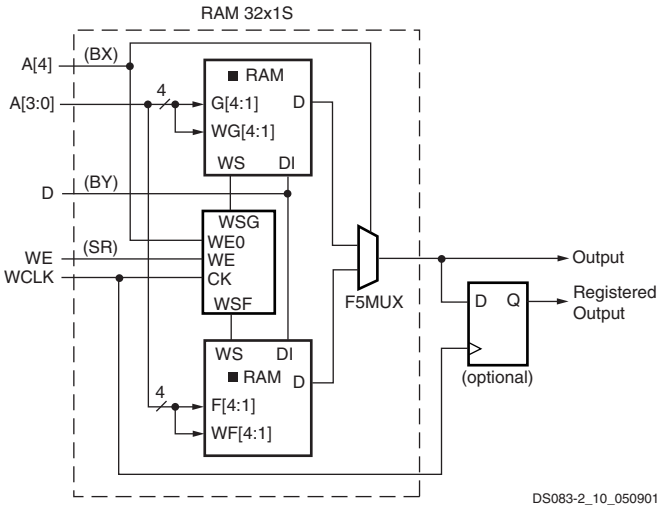

Figure 37: **Single-Port Distributed SelectRAM+ (RAM32x1S)**

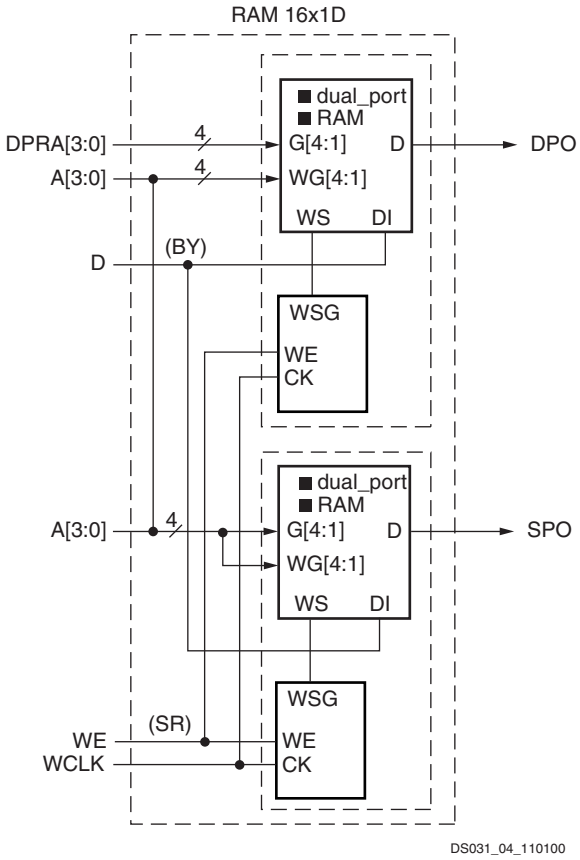

Figure 38: **Dual-Port Distributed SelectRAM+ (RAM16x1D)**

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 17 shows the number of LUTs occupied by each configuration.

Table 17: **ROM Configuration**

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Virtex-II Pro Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II Pro devices. The numbers reported here are fully characterized worst-case values. Note that these values are subject to the same guidelines as Virtex-II Pro Switching Characteristics (speed files).

Table 13 provides pin-to-pin values (in nanoseconds) including IOB delays; that is, delay through the device from input pin to output pin. In the case of multiple inputs and outputs, the worst delay is reported.

Table 13: **Pin-to-Pin Performance**

Description	Device Used & Speed Grade	Pin-to-Pin Performance (with I/O Delays)	Units
Basic Functions:			
16-bit Address Decoder	XC2VP20FF1152-6	7.20	ns
32-bit Address Decoder	XC2VP20FF1152-6	8.08	ns
64-bit Address Decoder	XC2VP20FF1152-6	8.15	ns
4:1 MUX	XC2VP20FF1152-6	3.85	ns
8:1 MUX	XC2VP20FF1152-6	7.24	ns
16:1 MUX	XC2VP20FF1152-6	7.30	ns
32:1 MUX	XC2VP20FF1152-6	7.64	ns
Combinatorial (pad to LUT to pad)	XC2VP20FF1152-6	3.26	ns
Memory:			
Block RAM			
Pad to setup	XC2VP20FF1152-6	1.72	ns
Clock to Pad	XC2VP20FF1152-6	6.63	ns
Distributed RAM			
Pad to setup	XC2VP20FF1152-6	1.78	ns
Clock to Pad	XC2VP20FF1152-6	4.12	ns

Table 25: **RocketIO Receiver Switching Characteristics**

Description	Symbol	Conditions	Min	Typ	Max	Units
Receive total jitter tolerance	T_{JTOL}	2.126 Gb/s – 3.125 Gb/s			0.65	UI(1)
		1.0626 Gb/s – 2.125 Gb/s			0.65	UI
		1.0 Gb/s – 1.0625 Gb/s			0.68	UI
		600 Mb/s – 999 Mb/s			0.68(2)	UI
Receive deterministic jitter tolerance	T_{DJTOL}	2.126 Gb/s – 3.125 Gb/s			0.41	UI
		1.0626 Gb/s – 2.125 Gb/s			0.43	UI
		1.0 Gb/s – 1.0625 Gb/s			0.47	UI
		600 Mb/s – 999 Mb/s			0.47(2)	
Receive latency(3)	T_{RXLAT}			25	42(4)	RXUSRCLK cycles
RXUSRCLK duty cycle	T_{RXDC}		45	50	55	%
RXUSRCLK2 duty cycle	T_{RX2DC}		45	50	55	%

Notes:

1. UI = Unit Interval
2. The oversampling techniques described in **XAPP572** are required to meet these specifications for serial rates less than 1 Gb/s.
3. Receive latency delay RXP/RXN to RXDATA. Refer to ***RocketIO Transceiver User Guide*** for more information on calculating latency.
4. This maximum may occur when certain conditions are present and clock correction and channel bonding are enabled. If these functions are both disabled, the maximum will be near the typical values.

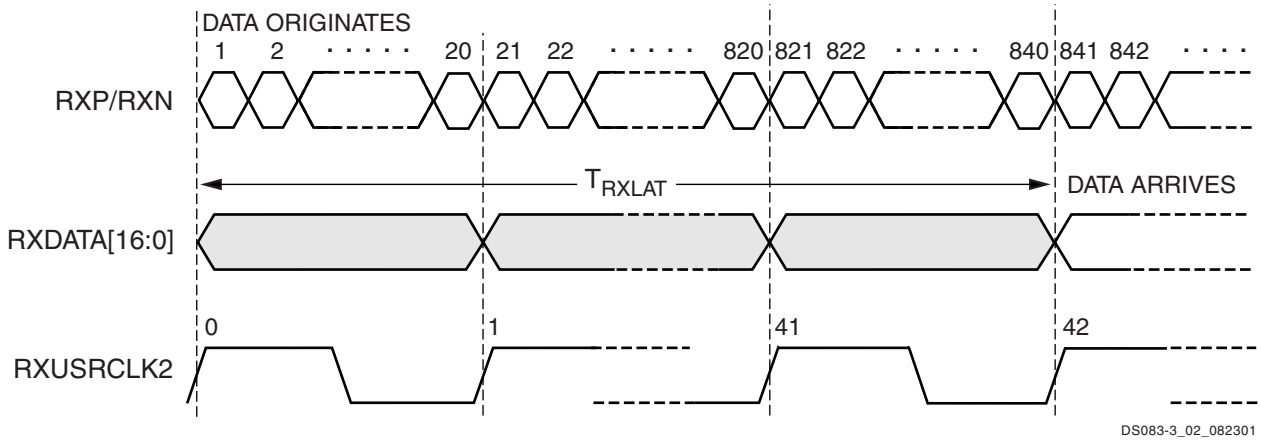

Figure 4: **RocketIO Receive Latency (Maximum)**

CLB Distributed RAM Switching Characteristics

Table 43: **CLB Distributed RAM Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Sequential Delays					
Clock CLK to X/Y outputs (WE active) in 16 x 1 mode	$T_{SHCKO16}$	1.25	1.38	1.54	ns, max
Clock CLK to X/Y outputs (WE active) in 32 x 1 mode	$T_{SHCKO32}$	1.57	1.75	1.95	ns, max
Clock CLK to F5 output	$T_{SHCKOF5}$	1.52	1.68	1.88	ns, max
Setup and Hold Times Before/After Clock CLK					
BX/BY data inputs (DIN)	T_{DS}/T_{DH}	0.38/–0.07	0.41/–0.07	0.46/–0.08	ns, min
F/G address inputs	T_{AS}/T_{AH}	0.42/ 0.00	0.47/ 0.00	0.52/ 0.00	ns, min
SR input	T_{WES}/T_{WEH}	0.22/ 0.04	0.24/ 0.05	0.26/ 0.05	ns, min
Clock CLK					
Minimum Pulse Width, High	T_{WPH}	0.63	0.72	0.79	ns, min
Minimum Pulse Width, Low	T_{WPL}	0.63	0.72	0.79	ns, min
Minimum clock period to meet address write cycle time	T_{WC}	1.25	1.44	1.58	ns, min

Notes:
1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values cannot be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

CLB Shift Register Switching Characteristics

Table 44: **CLB Shift Register Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Sequential Delays					
Clock CLK to X/Y outputs	T_{REG}	2.78	3.12	3.49	ns, max
Clock CLK to X/Y outputs	T_{REG32}	3.10	3.49	3.90	ns, max
Clock CLK to XB output via MC15 LUT output	T_{REGXB}	2.84	3.18	3.55	ns, max
Clock CLK to YB output via MC15 LUT output	T_{REGYB}	2.55	2.88	3.21	ns, max
Clock CLK to Shiftout	T_{CKSH}	2.50	2.83	3.15	ns, max
Clock CLK to F5 output	T_{REGF5}	3.05	3.42	3.83	ns, max
Setup and Hold Times Before/After Clock CLK					
BX/BY data inputs (DIN)	T_{SRLDS}/T_{SRLDH}	0.70/–0.16	0.77/–0.18	0.98/–0.21	ns, min
SR input	T_{WSS}/T_{WSH}	0.27/ 0.01	0.34/ 0.01	0.47/ 0.01	ns, min
Clock CLK					
Minimum Pulse Width, High	T_{SRPH}	0.63	0.72	0.79	ns, min
Minimum Pulse Width, Low	T_{SRPL}	0.63	0.72	0.79	ns, min

Notes:
1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values cannot be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

Table 46: **Pipelined Multiplier Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Setup and Hold Times Before/After Clock					
Data Inputs	$T_{MULIDCK}/T_{MULCKID}$	1.86/ 0.00	2.06/ 0.00	2.31/ 0.00	ns, max
Clock Enable	$T_{MULIDCK\_CE}/T_{MULCKID\_CE}$	0.23/ 0.00	0.25/ 0.00	0.28/ 0.00	ns, max
Reset	$T_{MULIDCK\_RST}/T_{MULCKID\_RST}$	0.21/–0.09	0.24/–0.09	0.26/–0.10	ns, max
Clock to Output Pin					
Clock to Pin35	T_{MULTCK_P35}	2.45	2.92	3.27	ns, max
Clock to Pin34	T_{MULTCK_P34}	2.36	2.82	3.16	ns, max
Clock to Pin33	T_{MULTCK_P33}	2.28	2.72	3.05	ns, max
Clock to Pin32	T_{MULTCK_P32}	2.20	2.62	2.93	ns, max
Clock to Pin31	T_{MULTCK_P31}	2.12	2.52	2.82	ns, max
Clock to Pin30	T_{MULTCK_P30}	2.03	2.42	2.71	ns, max
Clock to Pin29	T_{MULTCK_P29}	1.95	2.32	2.60	ns, max
Clock to Pin28	T_{MULTCK_P28}	1.87	2.22	2.48	ns, max
Clock to Pin27	T_{MULTCK_P27}	1.79	2.12	2.37	ns, max
Clock to Pin26	T_{MULTCK_P26}	1.70	2.02	2.26	ns, max
Clock to Pin25	T_{MULTCK_P25}	1.62	1.92	2.15	ns, max
Clock to Pin24	T_{MULTCK_P24}	1.54	1.82	2.03	ns, max
Clock to Pin23	T_{MULTCK_P23}	1.46	1.71	1.92	ns, max
Clock to Pin22	T_{MULTCK_P22}	1.37	1.61	1.81	ns, max
Clock to Pin21	T_{MULTCK_P21}	1.29	1.51	1.69	ns, max
Clock to Pin20	T_{MULTCK_P20}	1.21	1.41	1.58	ns, max
Clock to Pin19	T_{MULTCK_P19}	1.13	1.31	1.47	ns, max
Clock to Pin18	T_{MULTCK_P18}	1.04	1.21	1.36	ns, max
Clock to Pin17	T_{MULTCK_P17}	0.96	1.11	1.24	ns, max
Clock to Pin16	T_{MULTCK_P16}	0.88	1.01	1.13	ns, max
Clock to Pin15	T_{MULTCK_P15}	0.80	0.91	1.02	ns, max
Clock to Pin14	T_{MULTCK_P14}	0.71	0.81	0.91	ns, max
Clock to Pin13	T_{MULTCK_P13}	0.63	0.71	0.79	ns, max
Clock to Pin12	T_{MULTCK_P12}	0.63	0.71	0.79	ns, max
Clock to Pin11	T_{MULTCK_P11}	0.63	0.71	0.79	ns, max
Clock to Pin10	T_{MULTCK_P10}	0.63	0.71	0.79	ns, max
Clock to Pin9	T_{MULTCK_P9}	0.63	0.71	0.79	ns, max
Clock to Pin8	T_{MULTCK_P8}	0.63	0.71	0.79	ns, max
Clock to Pin7	T_{MULTCK_P7}	0.63	0.71	0.79	ns, max
Clock to Pin6	T_{MULTCK_P6}	0.63	0.71	0.79	ns, max
Clock to Pin5	T_{MULTCK_P5}	0.63	0.71	0.79	ns, max
Clock to Pin4	T_{MULTCK_P4}	0.63	0.71	0.79	ns, max
Clock to Pin3	T_{MULTCK_P3}	0.63	0.71	0.79	ns, max
Clock to Pin2	T_{MULTCK_P2}	0.63	0.71	0.79	ns, max
Clock to Pin1	T_{MULTCK_P1}	0.63	0.71	0.79	ns, max
Clock to Pin0	T_{MULTCK_P0}	0.63	0.71	0.79	ns, max

Output Clock Jitter

Table 59: **Output Clock Jitter**

Description	Symbol	Constraints	Speed Grade			Units
			–7	–6	–5	
Clock Synthesis Period Jitter						
CLK0	CLKOUT_PER_JITT_0		±100	±100	±100	ps
CLK90	CLKOUT_PER_JITT_90		±150	±150	±150	ps
CLK180	CLKOUT_PER_JITT_180		±150	±150	±150	ps
CLK270	CLKOUT_PER_JITT_270		±150	±150	±150	ps
CLK2X, CLK2X180	CLKOUT_PER_JITT_2X		±200	±200	±200	ps
CLKDV (integer division)	CLKOUT_PER_JITT_DV1		±150	±150	±150	ps
CLKDV (non-integer division)	CLKOUT_PER_JITT_DV2		±300	±300	±300	ps
CLKFX, CLKFX180	CLKOUT_PER_JITT_FX		Note (1)	Note (1)	Note (1)	ps

Notes:
1. Use the **Jitter Calculator** on the Xilinx website (http://www.xilinx.com/applications/web_ds_v2/jitter_calc.htm) for CLKFX and CLKFX180 output jitter.

Output Clock Phase Alignment

Table 60: **Output Clock Phase Alignment**

Description	Symbol	Constraints	Speed Grade			Units
			–7	–6	–5	
Phase Offset Between CLKIN and CLKFB						
CLKIN/CLKFB	CLKIN_CLKFB_PHASE		±50	±50	±50	ps
Phase Offset Between Any DCM Outputs						
All CLK* outputs	CLKOUT_PHASE		±140	±140	±140	ps
Duty Cycle Precision						
DLL outputs(1)	CLKOUT_DUTY_CYCLE_DLL(2)		±150	±150	±150	ps
CLKFX outputs	CLKOUT_DUTY_CYCLE_FX		±100	±100	±100	ps

Notes:
1. “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. CLKOUT_DUTY_CYCLE_DLL applies to the 1X clock outputs (CLK0, CLK90, CLK180, and CLK270) only if DUTY_CYCLE_CORRECTION = TRUE.
3. Specification also applies to PSCLK.

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
0	IO_L01N_0/VRP_0		E25			
0	IO_L01P_0/VRN_0		E24			
0	IO_L02N_0		F24			
0	IO_L02P_0		F23			
0	IO_L03N_0		E23			
0	IO_L03P_0/VREF_0		E22			
0	IO_L05_0/No_Pair		G23			
0	IO_L06N_0		H22			
0	IO_L06P_0		G22			
0	IO_L07N_0		F22			
0	IO_L07P_0		F21			
0	IO_L08N_0		D24			
0	IO_L08P_0		C24			
0	IO_L09N_0		H21			
0	IO_L09P_0/VREF_0		G21			
0	IO_L37N_0		E21			
0	IO_L37P_0		D21			
0	IO_L38N_0		D23			
0	IO_L38P_0		C23			
0	IO_L39N_0		H20			
0	IO_L39P_0		G20			
0	IO_L43N_0		E20			
0	IO_L43P_0		D20			
0	IO_L44N_0		B23			
0	IO_L44P_0		A23			
0	IO_L45N_0		H19			
0	IO_L45P_0/VREF_0		G19			
0	IO_L46N_0		E19	NC		
0	IO_L46P_0		E18	NC		
0	IO_L47N_0		C22	NC		
0	IO_L47P_0		B22	NC		
0	IO_L48N_0		F20	NC		
0	IO_L48P_0		F19	NC		
0	IO_L49N_0		G17	NC		
0	IO_L49P_0		F17	NC		
0	IO_L50_0/No_Pair		B21	NC		

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
3	IO_L06P_3	AL2				
3	IO_L05N_3	AG7				
3	IO_L05P_3	AH8				
3	IO_L04N_3	AH5				
3	IO_L04P_3	AH6				
3	IO_L03N_3/VREF_3	AK3				
3	IO_L03P_3	AK4				
3	IO_L02N_3	AJ7				
3	IO_L02P_3	AJ8				
3	IO_L01N_3/VRP_3	AJ4				
3	IO_L01P_3/VRN_3	AJ5				
4	IO_L01N_4/BUSY/DOUT(1)	AL5				
4	IO_L01P_4/INIT_B	AL6				
4	IO_L02N_4/D0/DIN(1)	AG9				
4	IO_L02P_4/D1	AH9				
4	IO_L03N_4/D2	AK6				
4	IO_L03P_4/D3	AK7				
4	IO_L05_4/No_Pair	AF10				
4	IO_L06N_4/VRP_4	AL7				
4	IO_L06P_4/VRN_4	AM7				
4	IO_L07N_4	AE11				
4	IO_L07P_4/VREF_4	AF11				
4	IO_L08N_4	AG10				
4	IO_L08P_4	AH10				
4	IO_L09N_4	AK8				
4	IO_L09P_4/VREF_4	AL8				
4	IO_L19N_4	AE12	NC	NC		
4	IO_L19P_4	AF12	NC	NC		
4	IO_L20N_4	AJ9	NC	NC		
4	IO_L20P_4	AK9	NC	NC		
4	IO_L21N_4	AL9	NC	NC		
4	IO_L21P_4	AM9	NC	NC		
4	IO_L25N_4	AG11	NC	NC		
4	IO_L25P_4	AH11	NC	NC		
4	IO_L26N_4	AH12	NC	NC		
4	IO_L26P_4	AJ12	NC	NC		
4	IO_L27N_4	AK10	NC	NC		

Table 10: **FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50**

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	VCCO_7	T23				
7	VCCO_7	U23				
N/A	CCLK	AE9				
N/A	PROG_B	J26				
N/A	DONE	AE10				
N/A	M0	AF26				
N/A	M1	AE26				
N/A	M2	AE25				
N/A	TCK	J9				
N/A	TDI	H28				
N/A	TDO	H7				
N/A	TMS	K10				
N/A	PWRDWN_B	AF9				
N/A	HSWAP_EN	K25				
N/A	RSVD	G8				
N/A	VBATT	K9				
N/A	DXP	K26				
N/A	DXN	G27				
N/A	AVCCAUXTX2	B32	NC	NC		
N/A	VTTXPAD2	B33	NC	NC		
N/A	TXNPAD2	A33	NC	NC		
N/A	TXPPAD2	A32	NC	NC		
N/A	GNDA2	C30	NC	NC		
N/A	RXPPAD2	A31	NC	NC		
N/A	RXNPAD2	A30	NC	NC		
N/A	VTRXPAD2	B31	NC	NC		
N/A	AVCCAUXRX2	B30	NC	NC		
N/A	AVCCAUXTX4	B28				
N/A	VTTXPAD4	B29				
N/A	TXNPAD4	A29				
N/A	TXPPAD4	A28				
N/A	GNDA4	C27				
N/A	RXPPAD4	A27				
N/A	RXNPAD4	A26				
N/A	VTRXPAD4	B27				
N/A	AVCCAUXRX4	B26				
N/A	AVCCAUXTX5	B24	NC	NC	NC	

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
1	IO_L75N_1/GCLK3P	C17		
1	IO_L75P_1/GCLK2S	B17		
1	IO_L74N_1/GCLK1P	L17		
1	IO_L74P_1/GCLK0S	K17		
1	IO_L73N_1	E17		
1	IO_L73P_1	D17		
1	IO_L69N_1/VREF_1	G17		
1	IO_L69P_1	F17		
1	IO_L68N_1	J17		
1	IO_L68P_1	H17		
1	IO_L67N_1	C16		
1	IO_L67P_1	B16		
1	IO_L66N_1/VREF_1	G16	NC	
1	IO_L66P_1	F16	NC	
1	IO_L57N_1/VREF_1	B15		
1	IO_L57P_1	A15		
1	IO_L56N_1	L16		
1	IO_L56P_1	K16		
1	IO_L55N_1	D16		
1	IO_L55P_1	C15		
1	IO_L54N_1	F15		
1	IO_L54P_1	E15		
1	IO_L53_1/No_Pair	H16		
1	IO_L50_1/No_Pair	G15		
1	IO_L49N_1	B14		
1	IO_L49P_1	A14		
1	IO_L48N_1	D14		
1	IO_L48P_1	C14		
1	IO_L47N_1	L15		
1	IO_L47P_1	K15		
1	IO_L46N_1	F14		
1	IO_L46P_1	E14		
1	IO_L45N_1/VREF_1	H14		
1	IO_L45P_1	G14		
1	IO_L44N_1	L14		
1	IO_L44P_1	K14		
1	IO_L43N_1	C13		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
7	IO_L13P_7	D28		
7	IO_L13N_7	E28		
7	IO_L12P_7	C33		
7	IO_L12N_7	C34		
7	IO_L11P_7	J27		
7	IO_L11N_7	K27		
7	IO_L10P_7	B30		
7	IO_L10N_7/VREF_7	C30		
7	IO_L09P_7	C28		
7	IO_L09N_7	C29		
7	IO_L08P_7	H27		
7	IO_L08N_7	H28		
7	IO_L07P_7	A32		
7	IO_L07N_7	B32		
7	IO_L06P_7	A31		
7	IO_L06N_7	B31		
7	IO_L05P_7	D27		
7	IO_L05N_7	E27		
7	IO_L04P_7	A29		
7	IO_L04N_7/VREF_7	B29		
7	IO_L03P_7	A28		
7	IO_L03N_7	B28		
7	IO_L02P_7	D26		
7	IO_L02N_7	C26		
7	IO_L01P_7/VRN_7	B26		
7	IO_L01N_7/VRP_7	B27		
7	VCCO_7	E33		
7	VCCO_7	R31		
7	VCCO_7	L31		
7	VCCO_7	G31		
7	VCCO_7	C31		
7	VCCO_7	R27		
7	VCCO_7	L27		
7	VCCO_7	G27		
7	VCCO_7	C27		
7	VCCO_7	J26		
7	VCCO_7	M24		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AF30		
N/A	GND	AB30		
N/A	GND	W30		
N/A	GND	T30		
N/A	GND	N30		
N/A	GND	J30		
N/A	GND	E30		
N/A	GND	A30		
N/A	GND	AP26		
N/A	GND	AK26		
N/A	GND	AB26		
N/A	GND	W26		
N/A	GND	T26		
N/A	GND	N26		
N/A	GND	E26		
N/A	GND	A26		
N/A	GND	AE25		
N/A	GND	K25		
N/A	GND	AP22		
N/A	GND	AK22		
N/A	GND	AF22		
N/A	GND	J22		
N/A	GND	E22		
N/A	GND	A22		
N/A	GND	Y21		
N/A	GND	W21		
N/A	GND	V21		
N/A	GND	U21		
N/A	GND	T21		
N/A	GND	R21		
N/A	GND	AA20		
N/A	GND	Y20		
N/A	GND	W20		
N/A	GND	V20		
N/A	GND	U20		
N/A	GND	T20		
N/A	GND	R20		
N/A	GND	P20		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP19		
N/A	GND	AK19		
N/A	GND	AF19		
N/A	GND	AA19		
N/A	GND	Y19		
N/A	GND	W19		
N/A	GND	V19		
N/A	GND	U19		
N/A	GND	T19		
N/A	GND	R19		
N/A	GND	P19		
N/A	GND	J19		
N/A	GND	E19		
N/A	GND	A19		
N/A	GND	AP18		
N/A	GND	AA18		
N/A	GND	Y18		
N/A	GND	W18		
N/A	GND	V18		
N/A	GND	U18		
N/A	GND	T18		
N/A	GND	R18		
N/A	GND	P18		
N/A	GND	A18		
N/A	GND	AA17		
N/A	GND	Y17		
N/A	GND	W17		
N/A	GND	V17		
N/A	GND	U17		
N/A	GND	T17		
N/A	GND	R17		
N/A	GND	P17		
N/A	GND	AP16		
N/A	GND	AK16		
N/A	GND	AF16		
N/A	GND	AA16		
N/A	GND	Y16		
N/A	GND	W16		

FF1704 Flip-Chip Fine-Pitch BGA Package

As shown in Table 13, XC2VP70 and XC2VP100 Virtex-II Pro devices are available in the FF1704 flip-chip fine-pitch BGA package. Following this table are the FF1704 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
0	IO_L01N_0/VRP_0		G34		
0	IO_L01P_0/VRN_0		H34		
0	IO_L02N_0		F34		
0	IO_L02P_0		E34		
0	IO_L03N_0		C34		
0	IO_L03P_0/VREF_0		D34		
0	IO_L05_0/No_Pair		K32		
0	IO_L06N_0		H33		
0	IO_L06P_0		J33		
0	IO_L07N_0		F33		
0	IO_L07P_0		G33		
0	IO_L08N_0		E33		
0	IO_L08P_0		D33		
0	IO_L09N_0		H32		
0	IO_L09P_0/VREF_0		J32		
0	IO_L19N_0		E32		
0	IO_L19P_0		F32		
0	IO_L20N_0		C33		
0	IO_L20P_0		C32		
0	IO_L21N_0		K31		
0	IO_L21P_0		L31		
0	IO_L25N_0		H31		
0	IO_L25P_0		J31		
0	IO_L26N_0		G31		
0	IO_L26P_0		F31		
0	IO_L27N_0		D31		
0	IO_L27P_0/VREF_0		E31		
0	IO_L28N_0		L30		
0	IO_L28P_0		M30		
0	IO_L29N_0		J30		
0	IO_L29P_0		K30		
0	IO_L30N_0		G30		
0	IO_L30P_0		H30		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
1	IO_L48N_1		J17		
1	IO_L48P_1		H17		
1	IO_L47N_1		K17		
1	IO_L47P_1		L17		
1	IO_L46N_1		M17		
1	IO_L46P_1		M18		
1	IO_L45N_1/VREF_1		F16		
1	IO_L45P_1		E16		
1	IO_L44N_1		G16		
1	IO_L44P_1		H16		
1	IO_L43N_1		K16		
1	IO_L43P_1		J16		
1	IO_L39N_1		M16		
1	IO_L39P_1		L16		
1	IO_L38N_1		C15		
1	IO_L38P_1		C14		
1	IO_L37N_1		F15		
1	IO_L37P_1		E15		
1	IO_L87N_1/VREF_1		J15	NC	
1	IO_L87P_1		H15	NC	
1	IO_L86N_1		K15	NC	
1	IO_L86P_1		L15	NC	
1	IO_L85N_1		E14	NC	
1	IO_L85P_1		D14	NC	
1	IO_L84N_1		G14	NC	
1	IO_L84P_1		F14	NC	
1	IO_L83_1/No_Pair		H14	NC	
1	IO_L78N_1		L14	NC	
1	IO_L78P_1		K14	NC	
1	IO_L36N_1/VREF_1		M14		
1	IO_L36P_1		M15		
1	IO_L35N_1		C13		
1	IO_L35P_1		D13		
1	IO_L34N_1		F13		
1	IO_L34P_1		E13		
1	IO_L30N_1		H13		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
3	IO_L53N_3		AE10		
3	IO_L53P_3		AE11		
3	IO_L52N_3		AE1		
3	IO_L52P_3		AE2		
3	IO_L51N_3/VREF_3		AE4		
3	IO_L51P_3		AE5		
3	IO_L50N_3		AF11		
3	IO_L50P_3		AE12		
3	IO_L49N_3		AE7		
3	IO_L49P_3		AE8		
3	IO_L48N_3		AF1		
3	IO_L48P_3		AF2		
3	IO_L47N_3		AG12		
3	IO_L47P_3		AF12		
3	IO_L46N_3		AF3		
3	IO_L46P_3		AF4		
3	IO_L45N_3/VREF_3		AF5		
3	IO_L45P_3		AF6		
3	IO_L44N_3		AF7		
3	IO_L44P_3		AF8		
3	IO_L43N_3		AF9		
3	IO_L43P_3		AF10		
3	IO_L42N_3		AG2		
3	IO_L42P_3		AG3		
3	IO_L41N_3		AG10		
3	IO_L41P_3		AG11		
3	IO_L40N_3		AG4		
3	IO_L40P_3		AG5		
3	IO_L39N_3/VREF_3		AG6		
3	IO_L39P_3		AG7		
3	IO_L38N_3		AG8		
3	IO_L38P_3		AH8		
3	IO_L37N_3		AH1		
3	IO_L37P_3		AH2		
3	IO_L36N_3		AH3		
3	IO_L36P_3		AJ3		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L03P_7		D37		
7	IO_L03N_7		E37		
7	IO_L02P_7		D36		
7	IO_L02N_7		E36		
7	IO_L01P_7/VRN_7		C37		
7	IO_L01N_7/VRP_7		C38		
0	VCCO_0		D25		
0	VCCO_0		G23		
0	VCCO_0		G28		
0	VCCO_0		G32		
0	VCCO_0		J25		
0	VCCO_0		J29		
0	VCCO_0		P22		
0	VCCO_0		P23		
0	VCCO_0		P24		
0	VCCO_0		P25		
0	VCCO_0		P26		
0	VCCO_0		R22		
0	VCCO_0		R23		
0	VCCO_0		R24		
0	VCCO_0		R25		
1	VCCO_1		R21		
1	VCCO_1		R20		
1	VCCO_1		R19		
1	VCCO_1		R18		
1	VCCO_1		P21		
1	VCCO_1		P20		
1	VCCO_1		P19		
1	VCCO_1		P18		
1	VCCO_1		P17		
1	VCCO_1		J18		
1	VCCO_1		J14		
1	VCCO_1		G20		
1	VCCO_1		G15		
1	VCCO_1		G11		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	TXPPAD11		A4		
N/A	GNDA11		C4		
N/A	RXPPAD11		A3		
N/A	RXNPAD11		A2		
N/A	VTRXPAD11		B3		
N/A	AVCCAUXRX11		B2		
N/A	AVCCAUXRX14		BA2		
N/A	VTRXPAD14		BA3		
N/A	RXNPAD14		BB2		
N/A	RXPPAD14		BB3		
N/A	GNDA14		AY4		
N/A	TXPPAD14		BB4		
N/A	TXNPAD14		BB5		
N/A	VTTXPAD14		BA5		
N/A	AVCCAUXTX14		BA4		
N/A	AVCCAUXRX15		BA6		
N/A	VTRXPAD15		BA7		
N/A	RXNPAD15		BB6		
N/A	RXPPAD15		BB7		
N/A	GNDA15		AY8		
N/A	TXPPAD15		BB8		
N/A	TXNPAD15		BB9		
N/A	VTTXPAD15		BA9		
N/A	AVCCAUXTX15		BA8		
N/A	AVCCAUXRX16		BA10		
N/A	VTRXPAD16		BA11		
N/A	RXNPAD16		BB10		
N/A	RXPPAD16		BB11		
N/A	GNDA16		AY12		
N/A	TXPPAD16		BB12		
N/A	TXNPAD16		BB13		
N/A	VTTXPAD16		BA13		
N/A	AVCCAUXTX16		BA12		
N/A	AVCCAUXRX17		BA14		
N/A	VTRXPAD17		BA15		
N/A	RXNPAD17		BB14		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		V6		
N/A	GND		U25		
N/A	GND		U24		
N/A	GND		U23		
N/A	GND		U22		
N/A	GND		U21		
N/A	GND		U20		
N/A	GND		U19		
N/A	GND		U18		
N/A	GND		T42		
N/A	GND		T1		
N/A	GND		R39		
N/A	GND		R36		
N/A	GND		R7		
N/A	GND		R4		
N/A	GND		M42		
N/A	GND		M1		
N/A	GND		L22		
N/A	GND		L21		
N/A	GND		K39		
N/A	GND		K4		
N/A	GND		J34		
N/A	GND		J9		
N/A	GND		H42		
N/A	GND		H35		
N/A	GND		H22		
N/A	GND		H21		
N/A	GND		H8		
N/A	GND		H1		
N/A	GND		G36		
N/A	GND		G7		
N/A	GND		F37		
N/A	GND		F25		
N/A	GND		F18		
N/A	GND		F6		
N/A	GND		E38		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L62N_6	AL35	
6	IO_L63P_6	AV36	
6	IO_L63N_6/VREF_6	AU36	
6	IO_L64P_6	AV35	
6	IO_L64N_6	AU35	
6	IO_L65P_6	AK35	
6	IO_L65N_6	AJ34	
6	IO_L66P_6	AU41	
6	IO_L66N_6	AU42	
6	IO_L67P_6	AU38	
6	IO_L67N_6	AT38	
6	IO_L68P_6	AK32	
6	IO_L68N_6	AK33	
6	IO_L69P_6	AU37	
6	IO_L69N_6/VREF_6	AT37	
6	IO_L70P_6	AT41	
6	IO_L70N_6	AT42	
6	IO_L71P_6	AK31	
6	IO_L71N_6	AJ31	
6	IO_L72P_6	AT39	
6	IO_L72N_6	AT40	
6	IO_L07P_6	AT35	
6	IO_L07N_6	AT36	
6	IO_L08P_6	AJ32	
6	IO_L08N_6	AJ33	
6	IO_L09P_6	AR42	
6	IO_L09N_6/VREF_6	AP41	
6	IO_L10P_6	AR40	
6	IO_L10N_6	AR41	
6	IO_L11P_6	AH34	
6	IO_L11N_6	AH35	
6	IO_L12P_6	AR38	
6	IO_L12N_6	AR39	
6	IO_L13P_6	AR36	
6	IO_L13N_6	AR37	
6	IO_L14P_6	AH32	
6	IO_L14N_6	AH33	